60V, 91A, 6.7mΩ N-channel Power SGT MOSFET

JMSL0609PGQ

Features

- Ultra-low ON-resistance, R_{DS(ON)}
- · Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant
- AEC-Q101 Qualified

Applications

- Load Switch
- PWM Application
- General Automotive Application

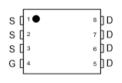
Product Summary

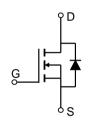
Parameters	Value	Unit
V_{DSS}	60	٧
$V_{GS(th)_Typ}$	1.5	٧
I _D (@V _{GS} =10V)	91	Α
$R_{DS(ON)_Typ}(@V_{GS}=10V$	5.1	mΩ
$R_{DS(ON)_Typ}(@V_{GS}=4.5V$	6.7	mΩ











PDFN5X6-8L

Pin Assignment

Schematic Diagram

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMSL0609PGQ-13	SL0609PQ	1	Tape&Reel	PDFN5x6-8L	5000	50000

Absolute Maximum Ratings (@ T_C = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		60	V
V_{GS}	Gate-to-Source Voltage		±20	V
I_	Continuous Drain Current	$T_C = 25^{\circ}C$	91	Α
I _D	Continuous Diain Current	$T_C = 100$ °C	64	A
I _{DM}	Pulsed Drain Current (1)	Pulsed Drain Current (1)		Α
E _{AS}	Single Pulsed Avalanche Energy	Single Pulsed Avalanche Energy (2)		mJ
P _D	Power Dissipation	$T_C = 25^{\circ}C$	107	W
гD	Fower Dissipation	$T_C = 100$ °C	54	VV
T_{J}, T_{STG}	Junction & Storage Temperature Range		-55 to 175	°C

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	44	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.1	1.5	2.1	V
R	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 20A$	-	5.1	6.6	mΩ
R _{DS(ON)}	Static Drain-Source ON-Resistance	$V_{GS} = 4.5V, I_D = 15A$	-	6.7	8.8	mΩ
Dynam i	ic Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	1.3	-	Ω
C _{iss}	Input Capacitance		-	1233	1849	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V$, $V_{DS} = 30V$, $f = 1MHz$	-	560	840	pF
C _{rss}	Reverse Transfer Capacitance	1 - 11/11/12	-	32	63	pF
Q_g	Total Gate Charge	V 0 4 40V	-	22	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 30V, I_D = 15A$	-	3.8	-	nC
Q_{gd}	Gate Drain("Miller") Charge	_ v _{DS} = 00 v, i _D = 10/1	-	4.7	-	nC
				•		
Switchi	ing Characteristics					
t _{d(on)}	Turn-On DelayTime		-	12	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	33	-	ns
t _{d(off)}	Turn-Off DelayTime	$I_D=15A, R_{GEN}=3\Omega$	-	20	-	ns
t _f	Turn-Off Fall Time		-	12	-	ns
Body D	iode Characteristics					
I _S	Maximum Continuous Body Diode Forward	Current	-	-	91	Α
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	364	А
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	1 - 204 di/dt - 1004///2	-	30	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	-	17	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

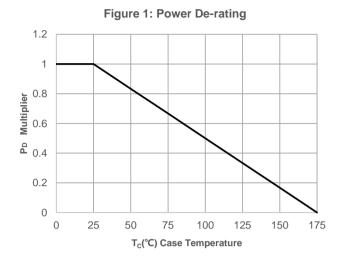
 $^{2.~}E_{AS}~condition:~Starting~T_J=25C,~V_{DD}=30V,~V_{GS}=10V,~R_G=25ohm,~L=3mH,~I_{AS}=7.7A,~V_{DD}=0V~during~time~in~avalanche.$

^{3.} $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.

^{4.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



Typical Performance Characteristics



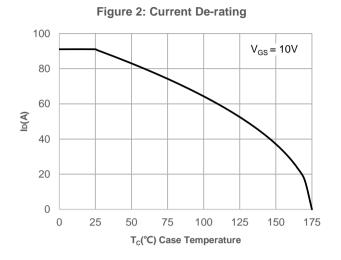
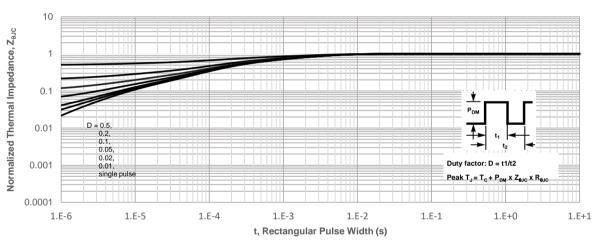
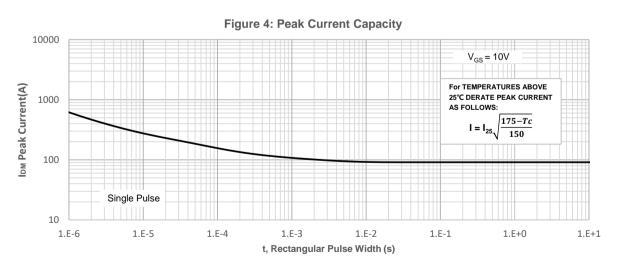


Figure 3: Normalized Maximum Transient Thermal Impedance







Typical Performance Characteristics

Figure 5: Output Characteristics

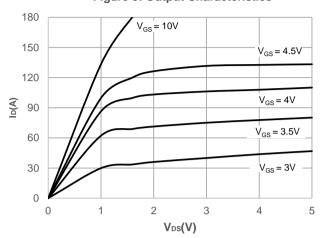


Figure 6: Typical Transfer Characteristics

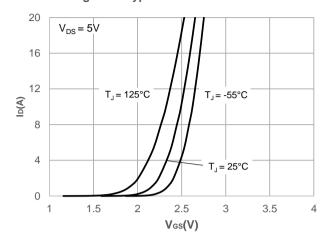


Figure 7: On-resistance vs. Drain Current

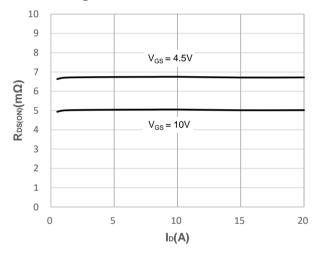


Figure 8: Body Diode Characteristics

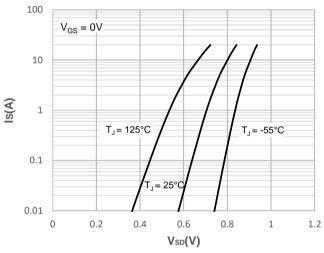


Figure 9: Gate Charge Characteristics

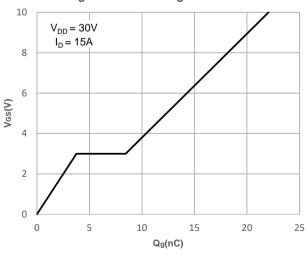
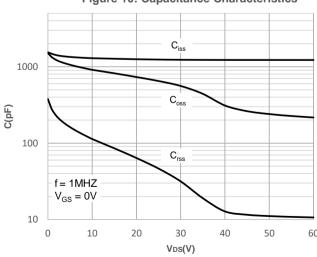


Figure 10: Capacitance Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

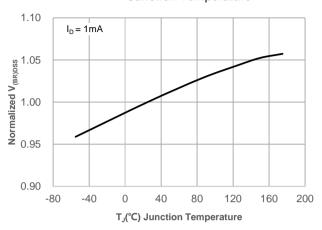


Figure 13: Normalized Threshold Voltage vs.
Junction Temperature

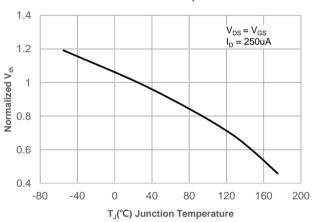


Figure 15: Maximum Safe Operating Area

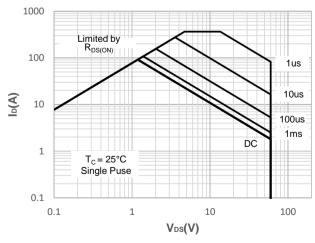
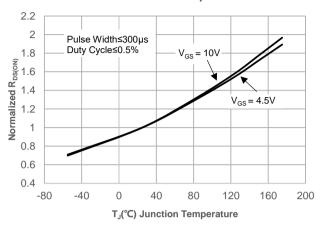
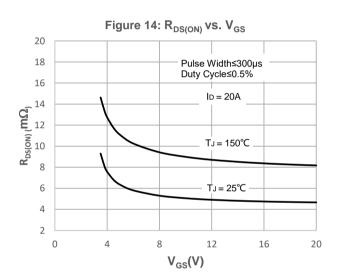


Figure 12: Normalized on Resistance vs.
Junction Temperature







Test Circuit

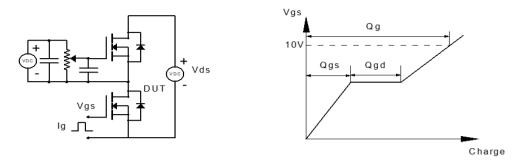


Figure 1: Gate Charge Test Circuit & Waveform

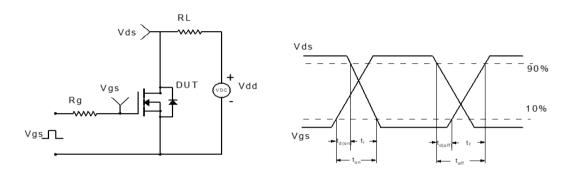


Figure 2: Resistive Switching Test Circuit & Waveform

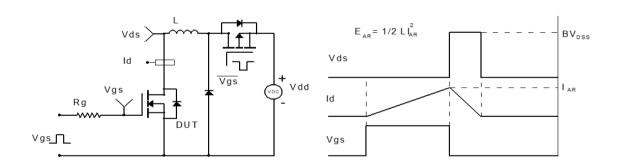


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

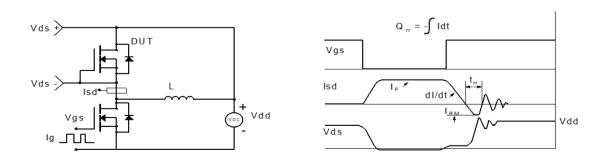
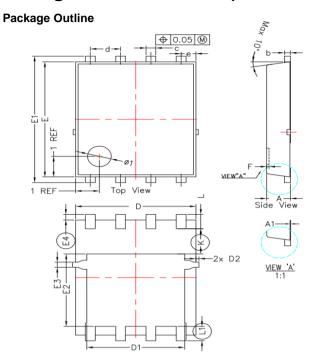


Figure 4: Diode Recovery Test Circuit & Waveform

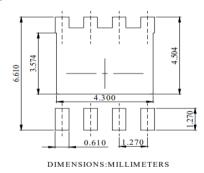


Package Mechanical Data(PDFN5X6-8L)



SYMBOLS	DIMENSION IN MM			DIMENSION IN INCHES			
JIWIDOLJ	MIN	NOM	MAX	MIN	NOM	MAX	
*A	0.900	1.000	1.150	0.035	0.039	0.045	
A1	0.000		0.050	0.000		0.002	
b	0.246	0.254	0.350	0.010	0.010	0.014	
*C	0.310	0.410	0.510	0.012	0.016	0.020	
d	1.27BSC				0.050BSC		
*D	4.950	5.050	5.150	0.195	0.199	0.203	
D1	4.000	4.100	4.200	0.157	0.161	0.165	
*D2	0.125REF			0.005REF			
e		0.62BSC		0.024BSC			
*E	5.500	5.600	5.700	0.217	0.220	0.224	
*E1	6.050	6.150	6.250	0.238	0.242	0.246	
E2	3.425	3.525	3.625	0.135	0.139	0.143	
E3	0.250REF			0.010REF			
* E4	0.275REF				0.011REF		
F	0.10		0.100	-	-	0.004	
*L	0.500	0.600	0.700	0.02	0.02	0.03	
L1	0.600	0.700	0.800	0.02	0.03	0.03	
K		1.225REF			0.05REF		

Recommended Soldering Footprint



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